505910138 02/11/2020

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT5956855

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
ANDREW DAVID FOREMAN	11/20/2019
CHARLOTTE BREE MEEKS	02/10/2020
ROBERT WEST	12/01/2019

RECEIVING PARTY DATA

Name:	QINETIQ LIMITED
Street Address:	CODY TECHNOLOGY PARK, IVELY ROAD
City:	FARNBOROUGH, HAMPSHIRE
State/Country:	UNITED KINGDOM
Postal Code:	GU14 0LX

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	16623321

CORRESPONDENCE DATA

Fax Number: (202)748-5915

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 2027485902

Email: jtuncay@kviplaw.com KENEALY VAIDYA LLP **Correspondent Name:** Address Line 1: 3000 K STREET, N.W.

Address Line 2: SUITE 200

Address Line 4: WASHINGTON, D.C. 20007

ATTORNEY DOCKET NUMBER:	5054-0043
NAME OF SUBMITTER:	ERIC D. MOREHOUSE
SIGNATURE:	/Eric D. Morehouse/
DATE SIGNED:	02/11/2020

Total Attachments: 6

source=02-11-20_Assignment_executed#page1.tif source=02-11-20 Assignment executed#page2.tif source=02-11-20 Assignment executed#page3.tif

> **PATENT** 505910138

REEL: 051783 FRAME: 0178

source=02-11-20_Assignment_executed#page4.tif
source=02-11-20_Assignment_executed#page5.tif
source=02-11-20_Assignment_executed#page6.tif

ASSIGNMENT

WHEREAS WE, the below named inventors, [hereinafter referred to as Assignors], have made an invention entitled:

MATERIALS COMPRISING SHAPE MEMORY ALLOY WIRES AND METHODS OF MAKING THESE MATERIALS

for which WE executed an application for United States Letters Patent concurrently herewith; and

WHEREAS <u>OinetiO Limited</u>, a corporation of United Kingdom, whose post office address is <u>Cody Technology Park</u>. <u>Ively Road</u>, <u>Famborough</u>, <u>Hampshire</u>, <u>GU14 OLX</u>, <u>United Kingdom</u>; [hereinafter referred to as Assignee], is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to the application of United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW THEREFORE, be it known that, for and in consideration of the sum of One Dollar (\$1.00) in hand paid and other good and valuable consideration the receipt of which from Assignee is hereby acknowledged, WE, as Assignors, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, and all rights to claim priority on the basis of such applications, and all applications for Letters Patent which may hereafter be filed for this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions, renewals, and reissues thereof; and WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent of this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, WE HEREBY covenant that WE have the full right to convey the interest assigned by this Assignment, and WE have not executed and will not execute any agreement in conflict with this Assignment;

AND, WE HEREBY further covenant and agree that WE will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to US respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns;

AND, WE HEREBY authorize and request the attorneys empowered in the Power of Attorney in this application, to insert here in parentheses (Application No. 16/623,321, filed 16-DEC-2019) the filing date and application number of said application when known.

KENEALY VAIDYA LLP

ATTORNEY DOCKET NO.: 5054-0043 U.S. Patent Application No.: 16/623,321 Page 2 of 2

IN TESTIMONY WHEREOF, I have hereunto set my hand.

Full Name of First Assignor Andrew David FOREMAN	Assignor's Signature	Date 20/11/19
Address: c/o QinetiQ Limited Cody Technology Park, Ively Road Farnborough, Hampshire GU14 0LX United Kingdom		<u>Citizenship</u> United Kingdom
Full Name of Second Assignor Charlotte Bree MEEKS	Assignor's Signature	<u>Date</u>
Address: c/o QinetiQ Limited Cody Technology Park, Ively Road Farnborough, Hampshire GU14 0LX United Kingdom	*	Citizenship United Kingdom
Full Name of Third Assignor Robert WEST	Assignor's Signature	Date
Address: c/o QinetiQ Limited Cody Technology Park, Ively Road Farnborough, Hampshire GU14 0LX United Kingdom		Citizenship United Kingdom
NAMES OF ADDITIONAL INVEN	TORS ATTACHED [] YES	[X] NO

KENEALY VAIDYA LLP

ASSIGNMENT

WHEREAS WE, the below named inventors, [hereinafter referred to as Assignors], have made an invention entitled:

MATERIALS COMPRISING SHAPE MEMORY ALLOY WIRES AND METHODS OF MAKING THESE MATERIALS

for which WE executed an application for United States Letters Patent concurrently herewith; and

WHEREAS <u>QinetiQ Limited</u>, a corporation of United Kingdom, whose post office address is <u>Cody Technology Park</u>, Ively Road, Famborough, Hampshire, <u>GU14 0LX</u>, <u>United Kingdom</u>; [hereinafter referred to as Assignee], is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to the application of United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW THEREFORE, be it known that, for and in consideration of the sum of One Dollar (\$1.00) in hand paid and other good and valuable consideration the receipt of which from Assignee is hereby acknowledged, WE, as Assignors, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, and all rights to claim priority on the basis of such applications, and all applications for Letters Patent which may hereafter be filed for this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions, renewals, and reissues thereof; and WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent of this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, WE HEREBY covenant that WE have the full right to convey the interest assigned by this Assignment, and WE have not executed and will not execute any agreement in conflict with this Assignment;

AND, WE HEREBY further covenant and agree that WE will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to US respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns;

AND, WE HEREBY authorize and request the attorneys empowered in the Power of Attorney in this application, to insert here in parentheses (Application No. 16/623,321, filed 16-DEC-2019) the filing date and application number of said application when known.

KENEALY VAIDYA LLP

ATTORNEY DOCKET NO.: 5054-0043 U.S. Patent Application No.: 16/623,321 Page 2 of 2

IN TESTIMONY WHEREOF, I have hereunto set my hand.

Full Name of First Assignor Andrew David FOREMAN	Assignor's Signature	Date
Address: c/o QinetiQ Limited Cody Technology Park, Ively Road Farnborough, Hampshire GU14 0LX United Kingdom		Citizenship United Kingdom
Full Name of Second Assignor Charlotte Bree MEEKS	Assignor's Signature	Date 10.2.2020
Address: c/o QinetiQ Limited Cody Technology Park, Ively Road Farnborough, Hampshire GU14 0LX United Kingdom		<u>Citizenship</u> United Kingdom
Full Name of Third Assignor Robert WEST	Assignor's Signature	Date
Address: c/o QinetiQ Limited Cody Technology Park, Ively Road Famborough, Hampshire GU14 0LX United Kingdom		Citizenship United Kingdom
NAMES OF ADDITIONAL INVENTORS ATTACHED [] YES [X] NO		

KENEALY VAIDYA LLP

ASSIGNMENT

WHEREAS WE, the below named inventors, [hereinafter referred to as Assignors], have made an invention entitled:

MATERIALS COMPRISING SHAPE MEMORY ALLOY WIRES AND METHODS OF MAKING THESE MATERIALS

for which WE executed an application for United States Letters Patent concurrently herewith; and

WHEREAS <u>QinetiQ Limited</u>, a corporation of United Kingdom, whose post office address is <u>Cody Technology Park</u>. Ively Road, <u>Famborough</u>, <u>Hampshire</u>, <u>GU14 0LX</u>, <u>United Kingdom</u>; [hereinafter referred to as Assignee], is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to the application of United States Letters Patent on this invention and the Letters Patent to be issued upon this application;

NOW THEREFORE, be it known that, for and in consideration of the sum of One Dollar (\$1.00) in hand paid and other good and valuable consideration the receipt of which from Assignee is hereby acknowledged, WE, as Assignors, have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the Assignee, its lawful successors and assigns, OUR entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, and all rights to claim priority on the basis of such applications, and all applications for Letters Patent which may hereafter be filed for this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions, renewals, and reissues thereof; and WE hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent of this invention to Assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, WE HEREBY covenant that WE have the full right to convey the interest assigned by this Assignment, and WE have not executed and will not execute any agreement in conflict with this Assignment;

AND, WE HEREBY further covenant and agree that WE will, without further consideration, communicate with Assignee, its successors and assigns, any facts known to US respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said Assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid Assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the Assignee, its successors and assigns;

AND, WE HEREBY authorize and request the attorneys empowered in the Power of Attorney in this application, to insert here in parentheses (Application No. 16/623,321, filed 16-DEC-2019) the filing date and application number of said application when known.

KENEALY VAIDYA LLP

ATTORNEY DOCKET NO.: 5054-0043 U.S. Patent Application No.: 16/623,321 Page 2 of 2

IN TESTIMONY WHEREOF, I have hereunto set my hand.

Full Name of First Assignor Andrew David FOREMAN	Assignor's Signature	Date
Address: c/o QinetiQ Limited Cody Technology Park, Ively Road Farnborough, Hampshire GU14 0LX United Kingdom	i	<u>Citizenship</u> United Kingdom
Full Name of Second Assignor Charlotte Bree MEEKS	Assignor's Signature	Date
Address: c/o QinetiQ Limited Cody Technology Park, Ively Road Famborough, Hampshire GU14 0LX United Kingdom		Citizenship United Kingdom
Full Name of Third Assignor Robert WEST	Assignor's Signature	Date 1/12/2019
Address: c/o QinetiQ Limited Cody Technology Park, Ively Road Farnborough, Hampshire GU14 0LX United Kingdom		Citizenship United Kingdom
NAMES OF ADDITIONAL INVEN	TORS ATTACHED [] YES	[X] NO

KENEALY VAIDYA LLP